

The Various Laminations Behavior Analysis of Heat Transfer for Composite Sandwich Structures

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ABSTRACT

The study is to analysis of heat transfer for composite sandwich structures and to establish forecast system. The behaviors of thermal conductivity of porous structures by series experiments and computer aided engineering (CAE) simulation with random processes, and the effective coefficient of thermal conductivity will also be calculated of the porosity.

The different porosities of material of thermal conductivity will be study by a series of experiments. EVA and AC foaming agent were used in this study. The commercial software of finite element methods – ANSYS was adopted to simulate heat transition of the porous structures. In order to create similar CAE models of foam, the random generation was applied to build the unit cell including hollow part and solid part. The CAE models include 2D models. The CAE results offer more precious than Carson ' s Effective Medium Theory (EMT). Finally, CAE simulations and numerical analysis were compared with heat transfer experiments and the result was agreed.

Keywords : Various Lamination、Computer Aided Engineering、Effective Analysis、Numerical Analysis

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REFERENCES

- [1] 蘇俊誠，”複合材料三明治結構件之二次發泡填充充壓製程開發與應用”，大葉大學工業工程與科技管理研究所工程系碩士論文，2007.6。
- [2] J.K. Carson, S.J. Lovatt, D.J. Tanner, A.C. Cleland, “ Thermal conductivity bounds for isotropic,porous materials, ” International Journal of Heat and Mass Transfer 48(2005)2150-2158.
- [3] 沈婉琳，”厚復材積層平板製程模擬分析與參數最佳化”，大葉大學工業工程與科技管理研究所工程系碩士論文，2007.2。
- [4] P. Cheng, H. Chin-Tsau, Heat conduction, D.B. Ingham, I. Pop (Eds.), “ Transport Phenomena in Porous Media, ” Pergamon press, 1998, pp. 57 – 76.
- [5] E. Tsotsas, H. Martin, “ Thermal conductivity of packed beds: A review, ” Chem. Eng. Process. 22 (1987) 19 – 37.
- [6] J.K. Carson, S.J. Lovatt, D.J. Tanner, A.C. Cleland, ” An analysis of the influence of material structure on the effective thermal conductivity of porous materials using finite element simulations, ” Int. J. Refrig. 26 (2003) 873 – 880.
- [7] Z. Hashin, S. Shtrikman, “ A variational approach to the theory of the effective magnetic permeability of multiphase materials, ” J. Appl. Phys. 33 (1962) 3125 – 3131.

- [8] R. Landauer, " The electrical resistance of binary metallic mixtures, " J. Appl. Phys. 23 (1952) 779 – 784.
- [9] S. Kirkpatrick, " Percolation and conduction, " Rev. Mod.Phys. 45 (1973) 574 – 588.
- [10] 張仲卿、林松浩、侯順雄，"熱傳遞"，高力圖書有限公司[11] L. Burden, J. Douglas Faires, " Numerical Analysis " ,brookscole.
- [12] Krishnakumer, K., " Micro-Genetic Algorithm for Stationary and Non-Stationary Function Optimization, " SPIE 1196, Intelligent Control and Adaptive Systems, 1989, pp. 289-296.
- [13] Shin, D. D., and Hahn, H. T., " Compaction of Thick Composites: Simulation and Experiment, " Polymer Composites, Vol. 25(1), 2004, pp. 49-59.